

WS

Chip Type, High CV
High Temperature (260°C) Reflow
series

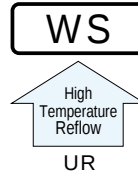


For SMD



Anti-Solvent
Feature

- Corresponding with 260°C peak reflow soldering
Recommended reflow condition : 260°C peak 5 sec. 230°C over 60 sec. 2 times
($\phi 8 \times 6.2$, $\phi 10 \times 10$: 1 time)
- Chip type higher capacitance in large case size.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).

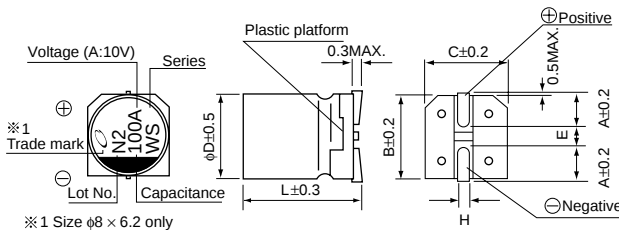


Specifications

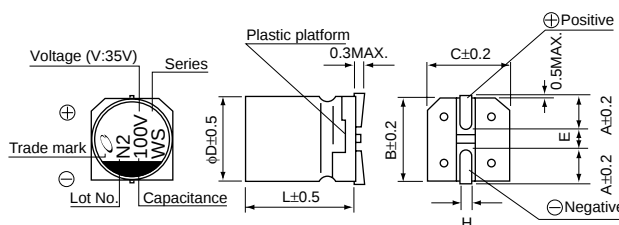
Item	Performance Characteristics							
Category Temperature Range	-40 ~ +85°C							
Rated Voltage Range	6.3 ~ 50V							
Rated Capacitance Range	22 ~ 1500μF							
Capacitance Tolerance	±20% at 120Hz, 20°C							
Leakage Current	After 1 minute's application of rated voltage, leakage current is not more than 0.03CV (μA) .							
tan δ	Measurement frequency : 120Hz, Temperature : 20°C							
	Rated voltage (V)	6.3	10	16	25	35	50	
	tan δ (MAX.)	0.28	0.24	0.20	0.16	0.14	0.12	
Stability at Low Temperature	Measurement frequency: 120Hz							
	Rated voltage (V)		6.3	10	16	25	35	50
	Impedance ratio ZT / Z20 (MAX.)	Z-25°C / Z+20°C	5	4	3	2	2	2
		Z-40°C / Z+20°C	10	8	6	4	3	3
Endurance	After 2000 hours' application of rated voltage at 85°C, capacitors meet the characteristic requirements listed at right.				Capacitance change		Within ±20% of initial value	
					tan δ		200% or less of initial specified value	
					Leakage current		Initial specified value or less	
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.							
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C, for 30 seconds. After removing from the hot plate and restored at room temperature, they meet the characteristic requirements listed at right.				Capacitance change		Within ±10% of initial value	
					tan δ		Initial specified value or less	
					Leakage current		Initial specified value or less	
Marking	Black print on the case top.							

Chip Type

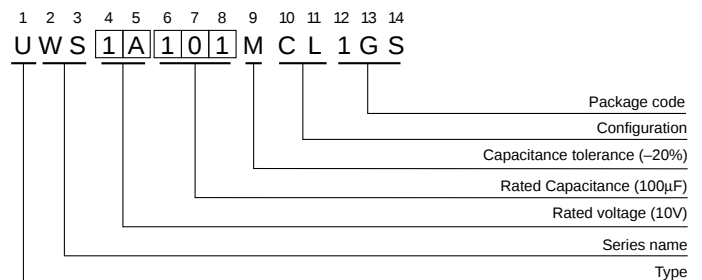
($\phi 6.3$, $\phi 8 \times 6.2$)



($\phi 8 \times 10$, $\phi 10 \times 10$)



Type numbering system (Example : 10V 100 μ F)



$\phi D \times L$	6.3 $\times$ 5.8	6.3 $\times$ 7.7	8 $\times$ 6.2	8 $\times$ 10	10 $\times$ 10
A	2.4	2.4	3.3	2.9	3.2
B	6.6	6.6	8.3	8.3	10.3
C	6.6	6.6	8.3	8.3	10.3
E	2.2	2.2	2.3	3.1	4.5
L	5.8	7.7	6.2	10	10
H	0.5 ~ 0.8	0.5 ~ 0.8	0.5 ~ 0.8	0.8 ~ 1.1	0.8 ~ 1.1

Voltage

V	6.3	10	16	25	35	50
Code	j	A	C	E	V	H

● Dimension table in next page.

■ Dimensions

Cap. (μF)	Code	V		6.3		10		16		25		35		50	
				0J		1A		1C		1E		1V		1H	
22	220													6.3 × 5.8	45
33	330											6.3 × 5.8	55	8 × 6.2	95
47	470									6.3 × 5.8	65	8 × 6.2	105	8 × 10	140
100	101				6.3 × 5.8	70	8 × 6.2	125	8 × 6.2	145	8 × 10	175	10 × 10	195	
150	151				6.3 × 5.8	85	6.3 × 7.7	151	8 × 10	192	8 × 10	214	10 × 10	238	
220	221	8 × 6.2	160	8 × 6.2	175	8 × 10	215	10 × 10	250	10 × 10	265	10 × 10	324		
330	331	8 × 6.2	190	8 × 10	240	8 × 10	270	10 × 10	305	10 × 10	324				
470	471	8 × 10	265	8 × 10	290	10 × 10	330	10 × 10	393						
680	681	8 × 10	318	10 × 10	374	10 × 10	396								
1000	102	10 × 10	400	10 × 10	454										
1500	152	10 × 10	489											Case size φ D × L (mm)	Rated ripple

Rated Ripple (mA_{rms}) at 85°C 120Hz

● Frequency coefficient of rated ripple current

Cap. (μF)	Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz~
~ 47		0.80	1.00	1.15	1.40	1.67
100 ~ 1500		0.85	1.00	1.08	1.20	1.30

- Taping specifications are given in page 24.
- Recommended land size, soldering by reflow are given in page 25, 26.
- Please refer to page 3 for the minimum order quantity.